# 24-Bit Analog-to-Digital Converter For Bridge Sensors 

## FEATURES

- Complete Front-End for Bridge Sensors
- Up to 23.5 Effective Bits
- Onboard, Low-Noise PGA
- RMS Noise:
$17 n V$ at 10SPS (PGA = 128)
$44 n \mathrm{n}$ at 80SPS (PGA = 128)
- 19.2-Bit Noise-Free Resolution at Gain = 64
- Over 100 dB Simultaneous 50 Hz and 60 Hz Rejection
- Flexible Clocking:

Low-Drift Onboard Oscillator ( $\pm 3 \%$ )
Optional External Crystal

- Selectable Gains of 1, 2, 64, and 128
- Easy Ratiometric MeasurementsExternal Voltage Reference up to 5V
- Selectable 10SPS or 80SPS Data Rates
- Two-Channel Differential Input with Built-In Temperature Sensor (ADS1232)
- Four-Channel Differential Input (ADS1234)
- Simple Serial Digital Interface
- Supply Range: 2.7 V to 5.3 V
- $-40^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$ Temperature Range


## DESCRIPTION

The ADS1232 and ADS1234 are precision 24-bit analog-to-digital converters (ADCs). With an onboard, low-noise programmable gain amplifier (PGA), precision delta-sigma ADC and internal oscillator, the ADS1232/4 provide a complete front-end solution for bridge sensor applications including weigh scales, strain gauges and pressure sensors.

The input multiplexer accepts either two (ADS1232) or four (ADS1234) differential inputs. The ADS1232 also includes an onboard temperature sensor to monitor ambient temperature. The onboard, low-noise PGA has a selectable gain of $1,2,64$, or 128 supporting a full-scale differential input of $\pm 2.5 \mathrm{~V}$, $\pm 1.25 \mathrm{~V}, \pm 39 \mathrm{mV}$, or $\pm 19.5 \mathrm{mV}$. The delta-sigma ADC has 23.5-bit effective resolution and is comprised of a 3rd-order modulator and 4th-order digital filter. Two data rates are supported: 10SPS (with both 50 Hz and 60 Hz rejection) and 80SPS. The ADS1232/4 can be clocked externally using an oscillator or a crystal. There is also an internal oscillator available that requires no external components. Offset calibration is performed on-demand and the ADS1232/4 can be put in a low-power standby mode or shut off completely in power-down mode. All of the features of the ADS1232/4 are operated through simple pin-driven control. There are no digital registers to program in order to simplify software development. Data are output over an easily-isolated serial interface that connects directly to the MSP430 and other microcontrollers.
The ADS1232 is available in a TSSOP-24 package and the ADS1234 is in a TSSOP-28. Both are fully specified from $-40^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$.

## APPLICATIONS

- Weigh Scales
- Strain Gauges
- Pressure Sensors
- Industrial Process Control


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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## ORDERING INFORMATION

For the most current package and ordering information, see the Package Option Addendum at the end of this data sheet, or see the TI website at www.ti.com.

## ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted) ${ }^{(1)}$

|  | ADS1232, ADS1234 | UNIT |
| :--- | :---: | :---: |
| AVDD to AGND | -0.3 to +6 | V |
| DVDD to DGND | -0.3 to +6 | V |
| AGND to DGND | -0.3 to +0.3 | V |
| Input Current | 100, Momentary | mA |
| Input Current | 10, Continuous | mA |
| Analog Input Voltage to AGND | -0.3 to AVDD +0.3 | V |
| Digital Input Voltage to DGND | -0.3 to DVDD +0.3 | V |
| Maximum Junction Temperature | +150 | ${ }^{\circ} \mathrm{C}$ |
| Operating Temperature Range | -40 to +105 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range | -60 to +150 | ${ }^{\circ} \mathrm{C}$ |

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## ELECTRICAL CHARACTERISTICS

All specifications at $T_{A}=-40^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}, \mathrm{AVDD}=\mathrm{DVDD}=\mathrm{VREFP}=+5 \mathrm{~V}$, and VREFN $=\mathrm{AGND}$, unless otherwise noted.

| PARAMETER | CONDITIONS | ADS1232, ADS1234 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX |  |
| Analog Inputs |  |  |  |  |  |
| Full-Scale Input Voltage (AINP - AINN) |  | $\pm 0.5 \mathrm{~V}_{\text {REF }} /$ Gain |  |  | V |
| Common-Mode Input Range | AINxP or AINxN with respect to GND, Gain $=1,2$ | AGND - 0.1 |  | AVDD + 0.1 | V |
|  | Gain $=64,128$ | AGND + 1.5V |  | AVDD - 1.5V | V |
| Differential Input Current | Gain = 1 | $\pm 3$ |  |  | nA |
|  | Gain = 2 | $\pm 6$ |  |  | nA |
|  | Gain $=64,128$ | $\pm 3.5$ |  |  | nA |
| System Performance |  |  |  |  |  |
| Resolution | No Missing Codes | 24 |  |  | Bits |
| Data Rate | Internal Oscillator, SPEED = High | 78 | 80 | 82.4 | SPS |
|  | Internal Oscillator, SPEED = Low | 9.75 | 10 | 10.3 | SPS |
|  | External Oscillator, SPEED = High | $\mathrm{f}_{\text {CLK } / 61,440}$ |  |  | SPS |
|  | External Oscillator, SPEED = Low | $\mathrm{f}_{\mathrm{CLK}} / 491,520$ |  |  | SPS |
| Digital Filter Settling Time | Full Settling | 4 |  |  | Conversions |
| Integral Nonlinearity (INL) | Differential Input, End-Point Fit Gain = 1, 2 | $\pm 0.0002 \pm 0.001$ |  |  | $\%$ of $\mathrm{FSR}^{(1)}$ |
|  | Differential Input, End-Point Fit Gain $=64,128$ | $\pm 0.0004$ |  |  | \% of FSR |
| Input Offset Error ${ }^{(2)}$ | Gain = 1 |  | $\pm 0.2$ | $\pm 5$ | ppm of FS |
|  | Gain = 128 |  | $\pm 0.02$ | $\pm 1$ | ppm of FS |
| Input Offset Drift | Gain = 1 | $\pm 0.3$ |  |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
|  | Gain $=128$ | $\pm 10$ |  |  | $\mathrm{nV} /{ }^{\circ} \mathrm{C}$ |
| Gain Error ${ }^{(3)}$ | Gain = 1 |  | $\pm 0.001$ | $\pm 0.02$ | \% |
|  | Gain $=128$ |  | $\pm 0.01$ | $\pm 0.1$ | \% |
| Gain Drift | Gain = 1 | $\pm 0.2$ |  |  | $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |
|  | Gain = 128 | $\pm 2.5$ |  |  | ppm $/{ }^{\circ} \mathrm{C}$ |
| Normal-Mode Rejection ${ }^{(4)}$ | Internal Oscillator, $\mathrm{f}_{\text {DATA }}=10 \mathrm{SPS}$ $\mathrm{f}_{\mathrm{IN}}=50 \mathrm{~Hz}$ or $60 \mathrm{~Hz}, \pm 1 \mathrm{~Hz}$ | 100110 |  |  | dB |
|  | External Oscillator, $\mathrm{f}_{\text {DATA }}=10 \mathrm{SPS}$ $\mathrm{f}_{\mathrm{IN}}=50 \mathrm{~Hz}$ or $60 \mathrm{~Hz}, \pm 1 \mathrm{~Hz}$ | 120130 |  |  | dB |
| Common-Mode Rejection | at DC , Gain $=1, \Delta \mathrm{~V}=1 \mathrm{~V}$ | 95 | 110 |  | dB |
|  | at DC , Gain $=128, \Delta \mathrm{~V}=0.1 \mathrm{~V}$ | 95 | 110 |  | dB |
| Input-Referred Noise |  | See Noise Performance Tables |  |  |  |
| Power-Supply Rejection | at DC , Gain $=1, \Delta \mathrm{~V}=1 \mathrm{~V}$ | 100120 |  |  | dB |
|  | at $\mathrm{DC}, \mathrm{Gain}=128, \Delta \mathrm{~V}=0.1 \mathrm{~V}$ | $100 \quad 120$ |  |  | dB |
| Voltage Reference Input |  |  |  |  |  |
| Voltage Reference Input ( $\mathrm{V}_{\text {REF }}$ ) | $\mathrm{V}_{\text {REF }}=$ VREFP -VREFN | 1.5 | AVDD | AVDD + 0.1V | V |
| Negative Reference Input (VREFN) |  | AGND - 0.1 | - | VREFP - 1.5 | V |
| Positive Reference Input (VREFP) |  | VREFN + 1.5 |  | AVDD + 0.1 | V |
| Voltage Reference Input Current |  |  | 10 |  | nA |

(1) FSR $=$ full-scale range $=V_{\text {REF }} /$ Gain.
(2) Offset calibration can minimize these errors to the level of noise at any temperature.
(3) Gain errors are calibrated at the factory ( $\mathrm{AVDD}=+5 \mathrm{~V}$, all gains, $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ ).
(4) Specification is assured by the combination of design and final production test.

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## ELECTRICAL CHARACTERISTICS (continued)

All specifications at $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}, \mathrm{AVDD}=\mathrm{DVDD}=\mathrm{VREFP}=+5 \mathrm{~V}$, and VREFN $=$ AGND, unless otherwise noted.

| PARAMETER | CONDITIONS | ADS1232, ADS1234 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX |  |
| Digital |  |  |  |  |  |
| Logic Levels |  |  |  |  |  |
| $\mathrm{V}_{1 \mathrm{H}}$ |  | 0.7 DVDD |  | DVDD + 0.1 | V |
| $\mathrm{V}_{\mathrm{IL}}$ |  | DGND |  | 0.2 DVDD | V |
| $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{I}_{\mathrm{OH}}=1 \mathrm{~mA}$ | DVDD - 0.4 |  |  | V |
| $\mathrm{V}_{\mathrm{OL}}$ | $\mathrm{I}_{\mathrm{OL}}=1 \mathrm{~mA}$ |  |  | 0.2 DVDD | V |
| Input Leakage | $0<\mathrm{V}_{\mathrm{IN}}<$ DVDD |  |  | $\pm 10$ | $\mu \mathrm{A}$ |
| External Clock Input Frequency (fCLKIN) |  | 0.2 | 4.9152 | 8 | MHz |
| Serial Clock Input Frequency ( $\mathrm{f}_{\text {ScLK }}$ ) |  |  |  | 5 | MHz |
| Power Supply |  |  |  |  |  |
| Power-Supply Voltage (AVDD, DVDD) |  | 2.7 |  | 5.3 | V |
| Analog Supply Current | Normal Mode, AVDD $=3 \mathrm{~V}$, Gain = 1, 2 |  | 600 | 1300 | $\mu \mathrm{A}$ |
|  | Normal Mode, AVDD $=3 \mathrm{~V}$, $\text { Gain }=64,128$ |  | 1350 | 2500 | $\mu \mathrm{A}$ |
|  | $\text { Normal Mode, AVDD }=5 \mathrm{~V} \text {, }$ $\text { Gain }=1,2$ |  | 650 | 1300 | $\mu \mathrm{A}$ |
|  | Normal Mode, AVDD $=5 \mathrm{~V}$, $\text { Gain }=64,128$ |  | 1350 | 2500 | $\mu \mathrm{A}$ |
|  | Standby Mode |  | 0.1 | 1 | $\mu \mathrm{A}$ |
|  | Power-Down |  | 0.1 | 1 | $\mu \mathrm{A}$ |
| Digital Supply Current | Normal Mode, DVDD $=3 \mathrm{~V}$, Gain = 1, 2 |  | 60 | 95 | $\mu \mathrm{A}$ |
|  | Normal Mode, DVDD $=3 \mathrm{~V}$, $\text { Gain }=64,128$ |  | 75 | 120 | $\mu \mathrm{A}$ |
|  | Normal Mode, DVDD $=5 \mathrm{~V}$, $\text { Gain }=1,2$ |  | 95 | 130 | $\mu \mathrm{A}$ |
|  | Normal mode, DVDD $=5 \mathrm{~V}$, Gain $=64,128$ |  | 75 | 120 | $\mu \mathrm{A}$ |
|  | Standby Mode, SCLK = High, DVDD $=3 \mathrm{~V}$ |  | 45 | 80 | $\mu \mathrm{A}$ |
|  | Standby Mode, SCLK = High, DVDD $=5 \mathrm{~V}$ |  | 65 | 80 | $\mu \mathrm{A}$ |
|  | Power-Down |  | 0.2 | 1.3 | $\mu \mathrm{A}$ |
| Power Dissipation, Total | $\begin{aligned} & \text { Normal Mode, AVDD }=\text { DVDD }=3 \mathrm{~V}, \\ & \text { Gain }=1,2 \end{aligned}$ |  | 2 | 4.2 | mW |
|  | $\begin{aligned} & \text { Normal Mode, AVDD }=\text { DVDD }=5 \mathrm{~V} \text {, } \\ & \text { Gain }=1,2 \end{aligned}$ |  | 3.7 | 7.2 | mW |
|  | Normal Mode, AVDD $=$ DVDD $=3 \mathrm{~V}$, $\text { Gain }=64,128$ |  | 4.3 | 7.9 | mW |
|  | $\begin{aligned} & \text { Normal Mode, AVDD }=\text { DVDD }=5 \mathrm{~V} \text {, } \\ & \text { Gain }=64,128 \end{aligned}$ |  | 7.1 | 13.1 | mW |
|  | Standby Mode, AVDD = DVDD $=5 \mathrm{~V}$ |  | 0.3 | 0.4 | mW |

## NOISE PERFORMANCE

The ADS1232/4 offer outstanding noise performance that can be optimized for a given full-scale range using the on-chip programmable gain amplifier. Table 1 through Table 4 summarize the typical noise performance with inputs shorted externally for different gains, data rates, and voltage reference values.

The RMS and Peak-to-Peak noise are referred to the input. The Effective Number of Bits (ENOB) is defined as:

- $E N O B=\ln (F S R / R M S ~ n o i s e) / \ln (2)$

The Noise-Free Bits are defined as:

- Noise-Free Bits = In (FSR/Peak-to-Peak Noise)/In(2)

Where FSR (Full-Scale Range) $=\mathrm{V}_{\text {REF }} /$ Gain
Table 1. $\mathrm{AVDD}=5 \mathrm{~V}, \mathrm{~V}_{\text {REF }}=5 \mathrm{~V}$, Data Rate $=10 \mathrm{SPS}$

| GAIN | RMS NOISE | PEAK-TO-PEAK NOISE $^{(1)}$ | ENOB (RMS) | NOISE-FREE BITS |
| :---: | :---: | :---: | :---: | :---: |
| 1 | 420 nV | $1.79 \mu \mathrm{~V}$ | 23.5 | 21.4 |
| 2 | 270 nV | 900 nV | 23.1 | 21.4 |
| 64 | 19 nV | 125 nV | 22.0 | 19.2 |
| 128 | 17 nV | 110 nV | 21.1 | 18.4 |

(1) Peak-to-peak noise data are based on direct measurement.

Table 2. AVDD $=5 \mathrm{~V}, \mathrm{~V}_{\text {REF }}=5 \mathrm{~V}$, Data Rate $=80 \mathrm{SPS}$

| GAIN | RMS NOISE | PEAK-TO-PEAK NOISE ${ }^{(1)}$ | ENOB (RMS) | NOISE-FREE BITS |
| :---: | :---: | :---: | :---: | :---: |
| 1 | $1.36 \mu \mathrm{~V}$ | $8.3 \mu \mathrm{~V}$ | 21.8 | 19.2 |
| 2 | 850 nV | $5.5 \mu \mathrm{~V}$ | 21.5 | 18.8 |
| 64 | 48 nV | 307 nV | 20.6 | 18 |
| 128 | 44 nV | 247 nV | 19.7 | 17.2 |

(1) Peak-to-peak noise data are based on direct measurement.

Table 3. AVDD $=3 \mathrm{~V}, \mathrm{~V}_{\text {REF }}=3 \mathrm{~V}$, Data Rate $=10 \mathrm{SPS}$

| GAIN | RMS NOISE | PEAK-TO-PEAK NOISE ${ }^{(1)}$ | ENOB (RMS) | NOISE-FREE BITS |
| :---: | :---: | :---: | :---: | :---: |
| 1 | 450 nV | $2.8 \mu \mathrm{~V}$ | 22.6 | 20 |
| 2 | 325 V | $1.8 \mu \mathrm{~V}$ | 22.1 | 19.7 |
| 64 | 20 nV | 130 nV | 21.2 | 18.5 |
| 128 | 18 nV | 115 nV | 20.3 | 17.6 |

(1) Peak-to-peak noise data are based on direct measurement.

Table 4. $\mathrm{AVDD}=3 \mathrm{~V}, \mathrm{~V}_{\text {REF }}=3 \mathrm{~V}$, Data Rate $=80 \mathrm{SPS}$

| GAIN | RMS NOISE | PEAK-TO-PEAK NOISE ${ }^{(1)}$ | ENOB (RMS) | NOISE-FREE BITS |
| :---: | :---: | :---: | :---: | :---: |
| 1 | $2.2 \mu \mathrm{~V}$ | $12 \mu \mathrm{~V}$ | 20.4 | 17.9 |
| 2 | $1.2 \mu \mathrm{~V}$ | $6.8 \mu \mathrm{~V}$ | 20.2 | 17.8 |
| 64 | 54 nV | 340 nV | 19.7 | 17.1 |
| 128 | 48 nV | 254 nV | 18.9 | 16.5 |

(1) Peak-to-peak noise data are based on direct measurement of 1024 samples.

## PIN CONFIGURATION



PIN DESCRIPTIONS

| NAME | TERMINAL |  | ANALOG/DIGITAL <br> INPUT/OUTPUT |  |
| :--- | :---: | :---: | :---: | :--- |
|  | ADS1232 | ADS1234 |  | Digital Power Supply: 2.7V to 5.3V |
| DVDD | 1 | 1 | 2 | Digital |
| DGND | 2 | Digital Ground |  |  |
| CLKIN/ <br> XTAL1 | 3 | 3 | Digital/Digital Input | External Clock Input: typically 4.9152MHz. Tie low to activate internal oscillator. Can also use <br> external crystal across CLKIN/XTAL1 and XTAL2 pins. See text for more details. |
| XTAL2 | 4 | 4 | Digital | External crystal connection |
| DGND | 5 | 5 | Digital | Digital Ground |
| DGND | 6 | 6 | Digital | Digital Ground |
| TEMP | 7 | - | Digital Input | Onboard Temperature Diode Enable |
|  |  |  |  |  |

TYPICAL CHARACTERISTICS
At $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{AVDD}=\mathrm{DVDD}=\mathrm{VREFP}=5 \mathrm{~V}$, and $\mathrm{VREFN}=\mathrm{AGND}$, unless otherwise noted.


Figure 1.
NOISE HISTOGRAM


Figure 3.


Figure 5.


Figure 2.
NOISE HISTOGRAM


Figure 4.
NOISE PLOT


Figure 6.

## TYPICAL CHARACTERISTICS (continued)

At $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{AVDD}=\mathrm{DVDD}=\mathrm{VREFP}=5 \mathrm{~V}$, and VREFN $=\mathrm{AGND}$, unless otherwise noted.


Figure 7.


Figure 9.


Gain Drift (ppm $/{ }^{\circ} \mathrm{C}$ )
Figure 11.


Figure 8.
OFFSET DRIFT $\left(+25^{\circ} \mathrm{C}\right.$ to $\left.+105^{\circ} \mathrm{C}\right)$


Figure 10.


Figure 12.

## TYPICAL CHARACTERISTICS (continued)

At $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, AVDD $=\mathrm{DVDD}=\mathrm{VREFP}=5 \mathrm{~V}$, and VREFN $=$ AGND, unless otherwise noted.


Figure 13.
GAIN DRIFT ( $\mathbf{- 4 0 ^ { \circ }} \mathbf{C}$ to $\mathbf{+ 2 5}{ }^{\circ} \mathrm{C}$ )


Figure 15.


Figure 17.


Figure 14.
GAIN DRIFT ( $+\mathbf{2 5}^{\circ} \mathrm{C}$ to $+\mathbf{1 0 5}^{\circ} \mathrm{C}$ )


Figure 16.


Figure 18.

## TYPICAL CHARACTERISTICS (continued)

At $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{AVDD}=\mathrm{DVDD}=\mathrm{VREFP}=5 \mathrm{~V}$, and VREFN $=$ AGND, unless otherwise noted.


Figure 19.


Figure 21.


Figure 23.


Figure 20.
INTEGRAL NONLINEARITY vs INPUT SIGNAL


Figure 22.
DIGITAL CURRENT vs TEMPERATURE


Figure 24.

## TYPICAL CHARACTERISTICS (continued)

At $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{AVDD}=\mathrm{DVDD}=\mathrm{VREFP}=5 \mathrm{~V}$, and $\mathrm{VREFN}=\mathrm{AGND}$, unless otherwise noted.


Figure 25.

## OVERVIEW

The ADS1232 and ADS1234 are highly integrated, 24-bit ADCs that include an input multiplexer, low-noise PGA, third-order delta-sigma ( $\Delta \Sigma$ ) modulator, and fourth-order digital filter. With input-referred RMS noise down to 17 nV , the ADS1232/4 are ideally suited for measuring the very low signals produced by bridge sensors in applications such as weigh scales, strain gauges, and pressure sensors.
Clocking can be supplied by an external oscillator, an external crystal, or by a precision internal oscillator. Data can be output at 10SPS for excellent 50 Hz and 60 Hz rejection, or at 80SPS when higher speeds are needed. The ADS1232/4 are easy to configure, and all digital control is accomplished through dedicated pins; there are no registers to program. A simple two-wire serial interface retrieves the data.

## ANALOG INPUTS (AINPx, AINNx)

The input signal to be measured is applied to the input pins AINPx and AINNx. The positive internal input is generalized as AINP, and the negative internal input generalized as AINN. The signal is selected through the input mux, which is controlled by pins A0 and A1 (ADS1234 only), as shown in Table 5. For the ADS1232, the A1 pin is replaced by the TEMP pin to activate the onboard diodes (see the Temperature Sensor section for more details). The ADS1232/4 accept differential input signals, but can also measure unipolar signals. When measuring unipolar (or single-ended signals) with respect to ground, connect the negative input (AINNx) to ground and connect the input signal to the positive input (AINPx). Note that when the ADS1232/4 are configured this way, only half of the converter full-scale range is used, since only positive digital output codes are produced.

Table 5. Input Channel Selection with A0 and A1 (ADS1234 only)

| MUX PINS |  | SELECTED ANALOG INPUTS |  |
| :---: | :---: | :---: | :---: |
| A1 | A0 | POSITIVE INPUT | NEGATIVE INPUT |
| 0 | 0 | AINP1 | AINN1 |
| 0 | 1 | AINP2 | AINN2 |
| 1 | 0 | AINP3 | AINN3 |
| 1 | 1 | AINP4 | AINN3 |

## TEMPERATURE SENSOR (ADS1232 only)

On-chip diodes provide temperature-sensing capability. By setting the TEMP pin high, the selected analog inputs are disconnected and the inputs to the ADC are connected to the anodes of two diodes scaled to 1 x and 80 x in current and size, as shown in Figure 26. By measuring the difference in voltage of these diodes, temperature changes can be inferred from a baseline temperature. Typically, the difference in diode voltage is 111.7 mV at $25^{\circ} \mathrm{C}$ with a temperature coefficient of $379 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$. With PGA $=1$ and 2, the difference voltage output from the PGA will be 111.7 mV and 223.4 mV , respectively. With PGA = 64 and 128, it is impossible to use the temperature sensor function. A similar structure is used in the MSC1210 for temperature measurement. For more information, see TI application report SBAA100, Using the MSC121x as a High-Precision Intelligent Temperature Sensor, available for download at www.ti.com.


Figure 26. Measurement of the Temperature Sensor in the Input Multiplexer

## LOW-NOISE PGA

The ADS1232/4 features a low-drift, low-noise PGA that provides a complete front-end solution for bridge sensors. A simplified diagram of the PGA is shown in Figure 27. It consists of two chopper-stabilized amplifiers (A1 and A2) and three accurately-matched resistors ( $R_{1}, R_{F 1}$, and $R_{F 2}$ ), which construct a differential front-end stage with a gain of 64 , followed by gain stage A3. The PGA inputs are equipped with an EMI filter, as shown in Figure 27. The cut-off frequency of the EMI filter is 19.6 MHz . If the PGA is set to 1 or 2, the gain-of-64 stage is bypassed and shut down to save power. With the combination of both gain stages, the PGA can be set to 64 or 128. The PGA of the ADS1232/4 can be set to 1, 2, 64, or 128 with pins GAIN1 (MSB) and GAINO (LSB). By using AVDD as the reference input, the bipolar input ranges from $\pm 2.5 \mathrm{~V}$ to $\pm 19.5 \mathrm{mV}$, while the unipolar ranges from 2.5 V to 19.5 mV . When the PGA is set to 1 or 2 , the absolute inputs can go rail-to-rail without significant performance degradation. However, the inputs of the ADS1232/4 are protected with internal diodes connected to the power-supply rails. These diodes will clamp the applied signal to prevent it from damaging the input circuitry. On the other hand, when the PGA is set to 64 or 128 , the operating input range is limited to (AGND +1.5 V ) to (AVDD -1.5 V ), in order to prevent saturating the differential front-end circuitry and degrading performance.


Figure 27. Simplified Diagram of the PGA

## Bypass Capacitor

By applying a $0.1 \mu \mathrm{~F}$ external capacitor ( $\mathrm{C}_{\mathrm{EXT}}$ ) across two capacitor pins and the combination of the internal $2 \mathrm{k} \Omega$ resistor $\mathrm{R}_{\text {INT }}$ on-chip, a low-pass filter (with a corner frequency of 720 Hz ) is created to bandlimit the signal path prior to the modulator input. This low-pass filter serves two purposes. First, the input signal is bandlimited to prevent aliasing as well as to filter out the high-frequency noise. Second, it attenuates the chopping residue from the PGA (for gains of 64 and 128 only) to improve temperature drift performance. It is not required to use high quality capacitors (such as ceramic or tantalum capacitors) for a general application. However, high quality capacitors such as poly are recommended for high linearity applications.

## VOLTAGE REFERENCE INPUTS (REFP, REFN)

The voltage reference used by the modulator is generated from the voltage difference between REFP and REFN: $V_{\text {REF }}=$ REFP - REFN. The reference inputs use a structure similar to that of the analog inputs. In order to increase the reference input impedance, a switching buffer circuitry is used to reduce the input equivalent capacitance. The reference drift and noise impact ADC performance. In order to achieve best results, pay close attention to the reference noise and drift specifications. A simplified diagram of the circuitry on the reference inputs is shown in Figure 28. The switches and capacitors can be modeled with an effective impedance of:
वョ $=\frac{\text { § }}{\text { Soth } \text { Ive }_{\text {ue }}}$
Where:
$f_{\text {MOD }}=$ modulator sampling frequency ( 76.8 kHz )
$C_{B U F}=$ input capacitance of the buffer
For the ADS1232/4:

$$
\mathrm{Z}_{\mathrm{EFF}}=\frac{1}{(2)(76.8 \mathrm{kHz})(13 \mathrm{fF})}=500 \mathrm{M} \Omega
$$



Figure 28. Simplified Reference Input Circuitry
ESD diodes protect the reference inputs. To prevent these diodes from turning on, make sure the voltages on the reference pins do not go below GND by more than 100 mV , and likewise, do not exceed AVDD by 100 mV :
GND $-100 \mathrm{mV}<($ REFP or REFN $)<$ AVDD +100 mV

## CLOCK SOURCES

The ADS1232/4 can use an external clock source, external crystal, or internal oscillator to accommodate a wide variety of applications. Figure 29 shows the equivalent circuitry of the clock source. The CLK_DETECT block determines whether the crystal oscillator/external clock signal is applied to the CLKIN/XTAL1 pin so that the internal oscillator is bypassed or activated. When the CLKIN/XTAL1 pin frequency is above $\sim 200 \mathrm{kHz}$, the CLK_DETECT output goes low and shuts down the internal oscillator. When the XIN pin frequency is below $\sim 200 \mathrm{kHz}$, the CLK_DETECT output goes high and activates the internal oscillator. It is highly recommended to hard-wire the CLKIN/XTAL1 pin to ground when the internal oscillator is chosen.


Figure 29. Equivalent Circuitry of the Clock Source

When the clock source is a crystal, simply connect the 4.9152 MHz crystal across the CLKIN/XTAL1 and XTAL2 pins. Table 6 shows the recommended part numbers. Due to the low-power design of the parallel resonant driver circuitry onboard, both the CLKIN/XTAL1 and XTAL2 pins are only for use with external crystals; they should not be used as clock output drivers for external circuitry. No external capacitors are used with the crystal; it is recommended to place the crystal close to the part in order to reduce board stray capacitance for both the CLKIN/XTAL1 and XTAL2 pins and to insure proper operation.

Table 6. Recommended Crystals

| MANUFACTURER | FREQUENCY | PART NUMBER |
| :---: | :---: | :---: |
| ECS | 4.9152 MHz | ECS-49-20-1 |
| ECS | 4.9152 MHz | ECS-49-20-4 |

An external oscillator may be used by driving the CLKIN/XTAL1 pin directly. The Electrical Characteristics table shows the allowable frequency range.

## FREQUENCY RESPONSE

The ADS1232/4 use a sinc ${ }^{4}$ digital filter with the frequency response ( $\mathrm{f}_{\text {cLK }}=4.9152 \mathrm{MHz}$ ) shown in Figure 30. The frequency response repeats at multiples of the modulator sampling frequency of 76.8 kHz . The overall response is that of a low-pass filter with a -3 dB cutoff frequency of 3.32 Hz with the SPEED pin tied low (10SPS data rate) and 11.64 Hz with the SPEED pin tied high (80SPS data rate).


Figure 30. Frequency Response
To help see the response at lower frequencies, Figure 31)(a) illustrates the response out to 100 Hz , when the data rate $=10$ SPS. Notice that signals at multiples of 10 Hz are rejected, and therefore simultaneous rejection of 50 Hz and 60 Hz is achieved.
The benefit of using a sinc ${ }^{4}$ filter is that every frequency notch has four zeros on the same location. This response, combined with the low drift internal oscillator, provides an excellent normal-mode rejection of line-cycle interference.

Figure 31)(b) shows the zoom in plot for both 50 Hz and 60 Hz notches with the SPEED pin tied low (10SPS data rate). With only a $\pm 3 \%$ variation of the internal oscillator, over 100 dB of normal-mode rejection is achieved.


Figure 31. Frequency Response Out To 100Hz
The ADS1232/4 data rate and frequency response scale directly with clock frequency. For example, if $\mathrm{f}_{\text {CLK }}$ increases from 4.9152 MHz to 6.144 MHz when the SPEED pin is tied high, the data rate increases from 80SPS to 100SPS, while notches also increase from 80 Hz to 100 Hz . Note that this is only possible when the external clock source is applied.

## SETTLING TIME

After changing the input multiplexer, the first data are fully settled. In both the ADS1232/4, the digital filter is allowed to settle after toggling either the A1 or A0 pin. Toggling any of these digital pins will hold the DRDY/DOUT line high until the digital filter is fully settled. For example, if A0 changes from low to high, selecting a different input channel, DRDY/DOUT immediately goes high, and DRDY/DOUT goes low when fully-settled data are ready for retrieval. There is no need to discard any data. Figure 32 shows the timing of the DRDY/DOUT line as the input multiplexer changes.

In certain instances, large and/or abrupt changes in input will require four data cycles to settle. One example of such a change would be an external multiplexer in front of the ADS1232/4, which can cause large changes in input voltage simply by
switching input channels. Another example would be toggling the TEMP pin, which switches the internal AINP, AINN signals to connect to either the external AINPx, AINNx pins or to the TEMP diode (see Figure 26).

Note that when settling data, five readings may be required. If the change in input occurs in the middle of the first conversion, four more full conversions of the fully-settled input are required to get fully-settled data. Discard the first four readings because they contain only partially-settled data.Figure 33 illustrates the settling time for the ADS1232/4 in Continuous Conversion mode.


Figure 32. Example of Settling Time After Changing the Input Multiplexer

| SYMBOL | DESCRIPTION ${ }^{(1)}$ | MIN | MAX | UNITS |
| :---: | :--- | :---: | :---: | :---: |
| $\mathrm{t}_{\mathbf{S}}$ | Setup time for changing the A1 or A0 pins | 40 | 50 | $\mu \mathrm{~s}$ |
| $\mathrm{t}_{1}$ | Settling time <br> held high) $\mathrm{DRDY/DOUT}$ | SPEED $=1$ | 51 | 51 |
|  | SPEED $=0$ | 401 | 401 | ms |

(1) Values given for $\mathrm{f}_{\mathrm{CLK}}=4.9152 \mathrm{MHz}$. For different $\mathrm{f}_{\mathrm{CLK}}$ frequencies, scale proportional to CLK period. Expect a $\pm 3 \%$ variation when an internal oscillator is used.


Figure 33. Settling Time in Continuous Conversion Mode

## DATA RATE

The ADS1232/4 data rate is set by the SPEED pin, as shown in Table 7. When SPEED is low, the data rate is nominally 10SPS. This data rate provides the lowest noise, and also has excellent rejection of both 50 Hz and 60 Hz line-cycle interference. For applications requiring fast data rates, setting SPEED high selects a data rate of nominally 80SPS.

Table 7. Data Rate Settings

| SPEED <br> PIN | DATA RATE <br> or 4.9152MHz Crystal | External <br> Oscillator |
| :---: | :---: | :---: |
|  | 10 SPS | $\mathrm{f}_{\text {CLKIN }} / 491,520$ |
|  | 80 SPS | $\mathrm{f}_{\text {CLKIN }} / 61,440$ |

## DATA FORMAT

The ADS1232/4 output 24 bits of data in binary two's complement format. The least significant bit (LSB) has a weight of $0.5 \mathrm{~V}_{\mathrm{REF}} /\left(2^{23}-1\right)$. The positive full-scale input produces an output code of 7FFFFFh and the negative full-scale input produces an output code of 800000 h . The output clips at these codes for signals exceeding full-scale. Table 8 summarizes the ideal output codes for different input signals.

Table 8. Ideal Output Code vs Input Signal ${ }^{(1)}$

| INPUT SIGNAL $V_{\text {IN }}$ (AINP - AINN) | IDEAL OUTPUT CODE |
| :---: | :---: |
| $\geq+0.5 \mathrm{~V}_{\text {REF }} /$ Gain | 7FFFFFh |
| $\left(+0.5 \mathrm{~V}_{\text {REF }} /\right.$ Gain)/( $\left.2^{23}-1\right)$ | 000001h |
| 0 | 000000h |
| $\left(-0.5 \mathrm{~V}_{\text {REF }} /\right.$ Gain $) /\left(2^{23}-1\right)$ | FFFFFFh |
| $\leq-0.5 \mathrm{~V}_{\text {REF }} /$ Gain | 800000h |

(1) Excludes effects of noise, INL, offset, and gain errors.

## DATA READY/DATA OUTPUT (DRDY/DOUT)

This digital output pin serves two purposes. First, it indicates when new data are ready by going low. Afterwards, on the first rising edge of SCLK, the DRDY/DOUT pin changes function and begins outputting the conversion data, most significant bit (MSB) first. Data are shifted out on each subsequent SCLK rising edge. After all 24 bits have been retrieved, the pin can be forced high with an additional SCLK. It will then stay high until new data are ready. This configuration is useful when polling on the status of DRDY/DOUT to determine when to begin data retrieval.

## SERIAL CLOCK INPUT (SCLK)

This digital input shifts serial data out with each rising edge. This input has built-in hysteresis, but care should still be taken to ensure a clean signal. Glitches or slow-rising signals can cause unwanted additional shifting. For this reason, it is best to make sure the rise-and-fall times of SCLK are less than 50 ns .

## DATA RETRIEVAL

The ADS1232/4 continuously convert the analog input signal. To retrieve data, wait until DRDY/DOUT goes low, as shown in Figure 34. After this occurs, begin shifting out the data by applying SCLKs. Data are shifted out MSB first. It is not required to shift out all 24 bits of data, but the data must be retrieved before new data are updated (within $\mathrm{t}_{7}$ ) or else it will be overwritten. Avoid data retrieval during the update period $\left(\mathrm{t}_{6}\right)$. DRDY/DOUT remains at the state of the last bit shifted out until it is taken high (see $\mathrm{t}_{6}$ ),
indicating that new data are being updated. To avoid having DRDY/DOUT remain in the state of the last bit, the user can shift SCLK to force DRDY/DOUT high, as shown in Figure 35. This technique is useful when a host controlling the device is polling $\overline{\text { DRDY/DOUT to determine when data are ready. }}$


Figure 34. Data Retrieval Timing

| SYMBOL | DESCRIPTION | MIN | TYP | MAX | UNITS |
| :---: | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{2}$ | $\overline{\text { DRDY/DOUT low to first SCLK rising edge }}$ | 0 |  |  | ns |
| $\mathrm{t}_{3}$ | SCLK positive or negative pulse width | 100 |  |  | ns |
| $\mathrm{t}_{4}$ | SCLK rising edge to new data bit valid: propagation <br> delay |  |  | 50 | ns |
| $\mathrm{t}_{5}$ | SCLK rising edge to old data bit valid: hold time | 0 |  |  | ns |
| $\mathrm{t}_{6}{ }^{(1)}$ | Data updating: no readback allowed | 39 |  |  |  |
| $\mathrm{t}_{7}{ }^{(1)}$ | Conversion time (1/data rate) | SPEED $=1$ |  | 12.5 |  |
|  | SPEED $=0$ |  | 100 | ms |  |

(1) Values given for $\mathrm{f}_{\text {CLK }}=4.9152 \mathrm{MHz}$. For different $\mathrm{f}_{\mathrm{CLK}}$ frequencies, scale proportional to CLK period.


Figure 35. Data Retrieval with $\overline{\text { DRDY/DOUT Forced High Afterwards }}$

## OFFSET CALIBRATION

Offset calibration can be initiated at any time to remove the ADS1232/4 inherited offset error. To initiate offset calibration, apply at least two additional SCLKs after retrieving 24 bits of data. Figure 36 shows the timing pattern. The 25th SCLK will send DRDY/DOUT high. The falling edge of the 26th SCLK will begin the calibration cycle. Additional SCLK pulses may be sent after the 26th SCLK; however, activity on SCLK should be minimized during offset calibration for best results.

When the calibration is completed, $\overline{\mathrm{DRDY} / D O U T}$ goes low, indicating that new data are ready. The analog input pins are disconnected within the ADC and the appropriate signal is applied internally to perform the calibration. The first conversion after a calibration is fully settled and valid for use. The offset calibration takes exactly the same time as specified in $\left(t_{8}\right)$ right after the falling edge of the 26 th SCLK.


Figure 36. Offset-Calibration Timing

| SYMBOL | DESCRIPTION | MIN | MAX | UNITS |  |
| :---: | :--- | :--- | :---: | :---: | :---: |
| $\mathrm{t}_{8}{ }^{(1)}$ | First data ready after calibration | SPEED $=1$ | 101.28 | 101.29 | ms |
|  |  | SPEED $=0$ | 801.02 | 801.03 | ms |

(1) Values given for $f_{C L K}=4.9152 \mathrm{MHz}$. For different $\mathrm{f}_{\mathrm{CLK}}$ frequencies, scale proportional to CLK period. Expect a $\pm 3 \%$ variation when an internal oscillator is used.

## STANDBY MODE

Standby mode dramatically reduces power consumption by shutting down most of the circuitry. In Standby mode, the entire analog circuitry is powered down and only the clock source circuitry is awake to reduce the wake-up time from the Standby mode. To enter Standby mode, simply hold SCLK high after DRDY/DOUT goes low; see Figure 37. Standby mode can be initiated at any time during readback; it is not necessary to retrieve all 24 bits of data beforehand.

When $t_{10}$ has passed with SCLK held high, Standby mode will activate. DRDY/DOUT stays high when Standby mode begins. SCLK must remain high to stay in Standby mode. To exit Standby mode (wakeup), set SCLK low. The first data after exiting Standby mode is valid.


Figure 37. Standby Mode Timing (can be used for single conversions)

| SYMBOL | DESCRIPTION | MIN | MAX | UNITS |  |
| :---: | :--- | :--- | :---: | :---: | :---: |
| $\mathrm{t}_{9}{ }^{(1)}$ | SCLK high after DRDY/DOUT goes low <br> to activate Standby mode | SPEED $=1$ | 0 | 12.44 | ms |
|  | SPEED $=0$ | 0 | 99.94 | ms |  |
| $\mathrm{t}_{10}{ }^{(1)}$ | Standby mode activation time | SPEED $=1$ | 12.46 |  | ms |
|  |  | SPEED $=0$ | 99.96 |  | ms |
| $\mathrm{t}_{11}{ }^{(1)}$ | Data ready after exiting Standby mode | SPEED $=1$ | 52.51 | 52.51 | ms |
|  |  | 401.8 | 401.8 | ms |  |

(1) Values given for $f_{C L K}=4.9152 \mathrm{MHz}$. For different $\mathrm{f}_{\mathrm{CLK}}$ frequencies, scale proportional to CLK period. Expect a $\pm 3 \%$ variation when an internal oscillator is used.

To force an offset-calibration with Standby mode, shift 25 SCLKs and take the SCLK pin high to enter Standby mode. Offset-calibration then begins after wake-up; see Figure 38 for the appropriate timing. Note the extra time needed after wake-up for calibration before data are ready. The first data after Standby mode with offset-calibration is fully settled and can be used right away.

## STANDBY MODE WITH OFFSET-CALIBRATION

Offset-calibration can be set to run immediately after exiting Standby mode. This is useful when the ADS1232/4 is put in Standby mode for long periods of time, and offset-calibration is desired afterwards to compensate for temperature or supply voltage changes.


Figure 38. Standby Mode with Offset-Calibration Timing (can be used for single conversions)

| SYMBOL | DESCRIPTION | MIN | MAX | UNITS |  |
| :---: | :--- | :--- | :---: | :---: | :---: |
| $\mathrm{t}_{12}{ }^{(1)}$ | Data ready after exiting Standby mode <br> and calibration | SPEED $=1$ | 103 | 103 | ms |
|  | SPEED $=0$ | 803 | 803 | ms |  |

(1) Values given for $f_{C L K}=4.9152 \mathrm{MHz}$. For different $f_{C L K}$ frequencies, scale proportional to CLK period. Expect a $\pm 3 \%$ variation when an internal oscillator is used.

## POWER-UP SEQUENCE

When powering up the ADS1232/34, AVDD and DVDD must be powered up before the PDWN pin goes high, as shown in Figure 39. If PDWN is not controlled by a microprocessor, a simple RC delay circuit must be implemented, as shown in Figure 40 .

## POWER-DOWN MODE

Power-Down mode shuts down the entire ADC circuitry and reduces the total power consumption close to zero. To enter Power-Down mode, simply hold the PDWN pin low. Power-Down mode also resets the entire circuitry to free the ADC circuitry from locking up to an unknown state. Power-Down mode can be initiated at any time during readback; it is not necessary to retrieve all 24 bits of data beforehand. Figure 41 shows the wake-up timing from Power-Down mode.


Figure 39. Power-Up Timing Sequence


Figure 40. RC Delay Circuit


Figure 41. Wake-Up Timing from Power-Down Mode

| SYMBOL | DESCRIPTION |  | TYP | UNITS |
| :---: | :---: | :---: | :---: | :---: |
| $t_{13}$ | Wake-up time after Power-Down mode | Internal clock | 7.95 | $\mu \mathrm{s}$ |
|  |  | External clock | 0.16 | $\mu \mathrm{s}$ |
|  |  | Crystal oscillator ${ }^{(1)}$ | 5.6 | ms |
| $\mathrm{t}_{14}{ }^{(2)}$ | PDWN pulse width |  | 26 (min) | $\mu \mathrm{s}$ |

(1) No capacitors on CLKIN/XTAL1 or XTAL2 outputs.
(2) Value given for $f_{C L K}=4.9152 \mathrm{MHz}$. For different $\mathrm{f}_{\mathrm{CLK}}$ frequencies, the scale is proportional to the CLK period except for a $\pm 3 \%$ variation when an internal oscillator is used.

## APPLICATION EXAMPLES

## Weigh-Scale System

Figure 42 shows a typical ADS1232 hook-up as part of a weigh-scale system. In this setup, the ADS1232 is configured to channel one input with a gain of 128 at a 10SPS data rate. Note that the internal oscillator is used by grounding the CLKIN/XTAL1 pin. The user can also apply either a 4.9152 MHz crystal across the CLKIN/XTAL1 and XTAL2 pins, or simply apply a clock to the CLKIN/XTAL1 pin. For a typical $2 \mathrm{mV} / \mathrm{V}$ load cell, the maximum output signal is approximately 10 mV for a single +5 V excitation voltage. The ADS1232/4 can achieve 18.4 noise-free bits at 10SPS when the PGA $=128$ (refer to Table 11). With the extra software filtering/averaging (typically done by a microprocessor), an extra bit can be expected.

Where:
$B I T_{\text {EFF }}=$ effective noise-free bits $(18.4+1$ bit from software filtering/averaging)
$F S_{L C}=$ full-scale output of the load cell $(10 \mathrm{mV})$
$F S_{A D}=$ full-scale input of the ADS1232/4 $(39 \mathrm{mV}$ when PGA = 128)

Therefore:

With +5 V supply voltage, 177,385 noise-free counts can be expected from the ADS1232/4 with the onboard PGA set to 128.

## Thermocouple

See Figure 43 for the ADS1232 in a thermocouple application. In this example, a type $k$ thermocouple is used; the temperature range is from $-260^{\circ} \mathrm{C}$ to $+900^{\circ} \mathrm{C}$ when the gain is set to 64 to maximize the full input range of the ADS1232. $R_{1}$ and a REF1004-2.5V are used to set the common-mode voltage to 2.5 V for ungrounded junction thermocouples. With a gain of 128, the ADS1232 input has a typical noise of $17 \mathrm{nV}_{\text {RMS }}$ for extremely high-resolution applications.
If either a wider temperature range application is required (up to $+1350^{\circ} \mathrm{C}$, for example), or a grounded junction thermocouple is used, pin 1 of the thermocouple can be grounded (see Figure 44). When the gain is set to 2, the ADS1232 input has a typical 500 nV offset error and a noise level of $270 \mathrm{nV}_{\text {RMS }}$, which is good for all kinds of low-voltage output sensors. Note that to calculate the actual thermocouple temperature, the ADS1232 internal temperature sensor can be accessed in order to measure the cold junction temperature along with the thermocouple reading.


Figure 42. Weigh Scale Application


Figure 43. Ungrounded Junction Thermocouple Application


Figure 44. Grounded Junction Thermocouple Application

## RTDs and Thermistors

Figure 45 shows a typical schematic for a style 2 (three-wire) RTD application. $\mathrm{R}_{1}$ and $\mathrm{R}_{2}$ are used to excite the RTD as well as establish the common-mode voltage of the ADS1232 PGA.

By using both differential channels of the ADS1232, the temperature change in lead resistance, $\mathrm{R}_{\mathrm{L}}$, can be eliminated. This condition is accomplished by using the following formula:
(AINP1 - AINN1) - 2(AINP2 - AINN2).


Figure 45. Style 2 (Three-Wire) RTD Schematic

## SUMMARY OF SERIAL INTERFACE WAVEFORMS



Figure 46. Summary of Serial Interface Waveforms

## Revision History

Changes from Revision E (October 2007) to Revision F Page

- Changed AVDD to deltaV in Common-Mode Rejection section in Electrical Characteristics table ..... 3
- Changed AVDD to deltaV in Power-Supply Rejection section in Electrical Characteristics table.... ..... 3
Changes from Revision D (September 2007) to Revision E- Corrected unit values in Electrical Characteristics table....................................................................................................... 3
Changes from Revision C (June 2006) to Revision D Page
- Deleted Logic Level $\mathrm{V}_{\mathrm{IH}}$ row for CLKIN/XTAL test condition in Electrical Characteristics ..... 3
- Added offset drift and gain drift histogram plots to Typical Characteristics (Figure 9 to Figure 16) ..... 9
- Changed difference voltage output for PGA $=2$ from 323.4 mV to 223.4 mV in Temperature Sensol section. ..... 13
- Added text to Voltage Reference InputS section regarding reference and drift noise ..... 14
- Changed $Z_{\text {EFF }}$ equation ..... 15
- Changed Figure 28 ..... 15
- Changed Figure 29 ..... 15
- Deleted last sentence of Clock Sources section . ..... 15
- Changed text in Settling Time section ..... 17
- Changed Figure 32 ..... 17
- Changed Figure 33 ..... 17
- Deleted 2nd sentence of Serial Clock Input section ..... 18
- Added Power-Up Sequence section, with new text and two new figures (Figure 39 and Figure 40) ..... 23
- Changed Figure 42. ..... 25
- Changed Figure 43 ..... 25
- Changed Figure 44 ..... 26
- Changed Figure 45 ..... 27
Changes from Revision B (September 2005) to Revision C Page
- Deleted last row from Absolute Maximum Ratings table. ..... 2
- Changed Analog Inputs section of Electrical Characteristics table ..... 3
- Changed the typical value in last row of Voltage Reference Input section of Electrical Characteristics table. ..... 3
- Added footnote 1 to Table 1, Table 3, Table 3, and Table 4. ..... 5
- Changed fourth sentence in Temperature Sensor section of Overview. ..... 13
- Added fifth and sixth sentences to Temperature Sensor section of Overview. ..... 13
- Added fourth and fifth sentences to Low-Noise PGA section of Overview. ..... 14
- Changed Figure 27. ..... 14
- Changed $t_{11}$ to $t_{10}$ in third paragraph of Standby Mode section of Overview. ..... 21
- Changed min and max variables of $\mathrm{t}_{10}$ row in table below Figure 37. ..... 21
- Changed Figure 41. ..... 23
- Added last row and second footnote to table below Figure 41. ..... 23


## PACKAGING INFORMATION

| Orderable Device | Status ${ }^{(1)}$ | Package <br> Type | Package <br> Drawing | Pins Package <br> Qty | Eco Plan ${ }^{(2)}$ | Lead/Ball Finish | MSL Peak Temp ${ }^{(3)}$ |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ADS1232IPW | ACTIVE | TSSOP | PW | 24 | 60 |  <br> no Sb/Br) | CU NIPDAU | Level-2-260C-1 YEAR |
| ADS1232IPWG4 | ACTIVE | TSSOP | PW | 24 | 60 |  <br> no Sb/Br) | CU NIPDAU | Level-2-260C-1 YEAR |
| ADS1232IPWR | ACTIVE | TSSOP | PW | 24 | 2000 |  <br> no Sb/Br) | CU NIPDAU | Level-2-260C-1 YEAR |
| ADS1232IPWRG4 | ACTIVE | TSSOP | PW | 24 | 2000 |  <br> no Sb/Br) | CU NIPDAU | Level-2-260C-1 YEAR |
| ADS1234IPW | ACTIVE | TSSOP | PW | 28 | 50 |  <br> no Sb/Br) | CU NIPDAU | Level-2-260C-1 YEAR |
| ADS1234IPWG4 | ACTIVE | TSSOP | PW | 28 | 50 |  <br> no Sb/Br) | CU NIPDAU | Level-2-260C-1 YEAR |
| ADS1234IPWR | ACTIVE | TSSOP | PW | 28 | 2000 |  <br> no Sb/Br) | CU NIPDAU | Level-2-260C-1 YEAR |
| ADS1234IPWRG4 | ACTIVE | TSSOP | PW | 28 | 2000 |  <br> no Sb/Br) | CU NIPDAU | Level-2-260C-1 YEAR |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but Tl does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS \& no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The $\mathrm{Pb}-\mathrm{Free} / \mathrm{Green}$ conversion plan has not been defined.
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Green (RoHS \& no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine ( Br ) and Antimony ( Sb ) based flame retardants ( Br or Sb do not exceed $0.1 \%$ by weight in homogeneous material)
${ }^{(3)}$ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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## TAPE AND REEL INFORMATION



| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | $\begin{gathered} \mathrm{P} 1 \\ (\mathrm{~mm}) \end{gathered}$ | $\begin{gathered} \mathrm{W} \\ (\mathrm{~mm}) \end{gathered}$ | Pin1 Quadrant |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ADS1232IPWR | TSSOP | PW | 24 | 2000 | 330.0 | 16.4 | 6.95 | 8.3 | 1.6 | 8.0 | 16.0 | Q1 |
| ADS1234IPWR | TSSOP | PW | 28 | 2000 | 330.0 | 16.4 | 6.9 | 10.2 | 1.8 | 12.0 | 16.0 | Q1 |


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ADS1232IPWR | TSSOP | PW | 24 | 2000 | 346.0 | 346.0 | 33.0 |
| ADS1234IPWR | TSSOP | PW | 28 | 2000 | 346.0 | 346.0 | 33.0 |



| PIM PINS | $\mathbf{8}$ | $\mathbf{1 4}$ | $\mathbf{1 6}$ | $\mathbf{2 0}$ | $\mathbf{2 4}$ | $\mathbf{2 8}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A MAX | 3,10 | 5,10 | 5,10 | 6,60 | 7,90 | 9,80 |
| A MIN | 2,90 | 4,90 | 4,90 | 6,40 | 7,70 | 9,60 |

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15 .
D. Falls within JEDEC MO-153

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